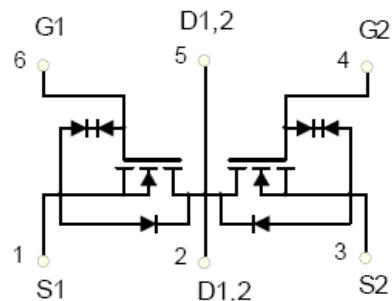
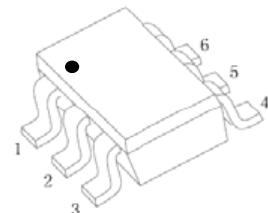


DESCRIPTION

The PT8810 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. It is ESD protected. This device is suitable for use as a uni-directional or bi-directional load switch, facilitated by its common-drain configuration.

V_{(BR)DSS}	R_{DS(on)}MAX	I_D
20V	22mΩ@4.5V	7A
	26mΩ@2.5V	
	35mΩ@1.8V	

SOT-23-6L



MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current	I_D	7	A
Pulsed Drain Current	I_{DM}^*	30	A
Thermal Resistance from Junction to Ambient	$R_{\theta JA}^{**}$	208.3	°C/W
Junction Temperature	T_j	150	°C
Storage Temperature	T_{stg}	-55~+150	°C
Lead Temperature for Soldering Purposes(1/8" from case for 10 s)	T_L	260	°C

*Repetitive rating: Pulse width limited by junction temperature.

******Surface mounted on FR4 board using 1 square inch pad size,1oz single-side copper.

T_a=25 °C unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	V _(BR) DSS	V _{GS} = 0V, I _D = 250μA	20			V
Zero gate voltage drain current	I _{DSS}	V _{DS} = 16V, V _{GS} = 0V			1	μA
Gate-body leakage current	I _{GSS}	V _{GS} = ±4.5V, V _{DS} = 0V			±1	μA
		V _{GS} = ±8V, V _{DS} = 0V			±10	μA
Gate threshold voltage (note 1)	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	0.4	0.77	1	V
Drain-source on-resistance (note 1)	R _{D(on)}	V _{GS} = 4.5V, I _D = 6.6A		16	22	mΩ
		V _{GS} = 2.5V, I _D = 5.5A		20	26	mΩ
		V _{GS} = 1.8V, I _D = 5A		28	35	mΩ
Forward tranconductance (note 1)	g _{FS}	V _{DS} = 5V, I _D = 7A	9			S
Diode forward voltage(note 1)	V _{SD}	I _S =1A, V _{GS} = 0V			1	V
DYNAMIC PARAMETERS (note 2)						
Input Capacitance	C _{iss}	V _{DS} = 10V, V _{GS} = 0V, f = 1MHz		1150		pF
Output Capacitance	C _{oss}			185		pF
Reverse Transfer Capacitance	C _{rss}			145		pF
Total gate charge	Q _g	V _{DS} = 10V, V _{GS} = 4.5V, I _D = 7A		15		nC
Gate-source charge	Q _{gs}			0.8		nC
Gate-drain charge	Q _{gd}			3.2		nC
SWITCHING PARAMETERS(note 2)						
Turn-on delay time	t _{d(on)}	V _{GS} =5V, V _{DD} =10V, R _L =1.35Ω, R _{GEN} =3Ω		6		ns
Turn-on rise time	t _r			13		ns
Turn-off delay time	t _{d(off)}			52		ns
Turn-off fall time	t _f			16		ns

Notes :

1. Pulse Test : Pulse width≤300μs, duty cycle≤0.5%.
2. Guaranteed by design, not subject to production testing.

Typical Characteristics

